

FDP6N60ZU / FDPF6N60ZUT N-Channel MOSFET, FRFET 600V, 4.5A, 2Ω

Features

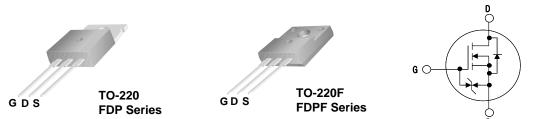
- $R_{DS(on)} = 1.7\Omega$ (Typ.) @ $V_{GS} = 10V$, $I_D = 2.25A$
- Low gate charge (Typ. 14.5nC)
- Low C_{rss} (Typ. 5pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- RoHS compliant



Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies and active power factor correction.



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol			FDP6N60ZU	FDPF6N60ZUT	Units		
V _{DSS}	Drain to Source Voltage			600		V	
V _{GSS}	Gate to Source Voltage		±30		V		
ID	Drain Current	-Continuous (T _C = 25 ^o C)		4.5	4.5*	•	
		-Continuous ($T_C = 100^{\circ}C$)		2.7	2.7*	A	
I _{DM}	Drain Current	- Pulsed (Note 1)		18	18*	А	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	150		mJ	
I _{AR}	Avalanche Current		(Note 1)	4.5		А	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	10.5		mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	20		V/ns	
P _D	Power Dissinction	$(T_{C} = 25^{\circ}C)$		105	33.8	W	
	Power Dissipation	- Derate above 25°C		0.85	0.27	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150		°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300		°C	

Symbol	Parameter	FDP6N60ZU	FDPF6N60ZUT	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.2	3.7	
$R_{\theta CS}$	Thermal Resistance, Case to Sink Typ.	0.5	-	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

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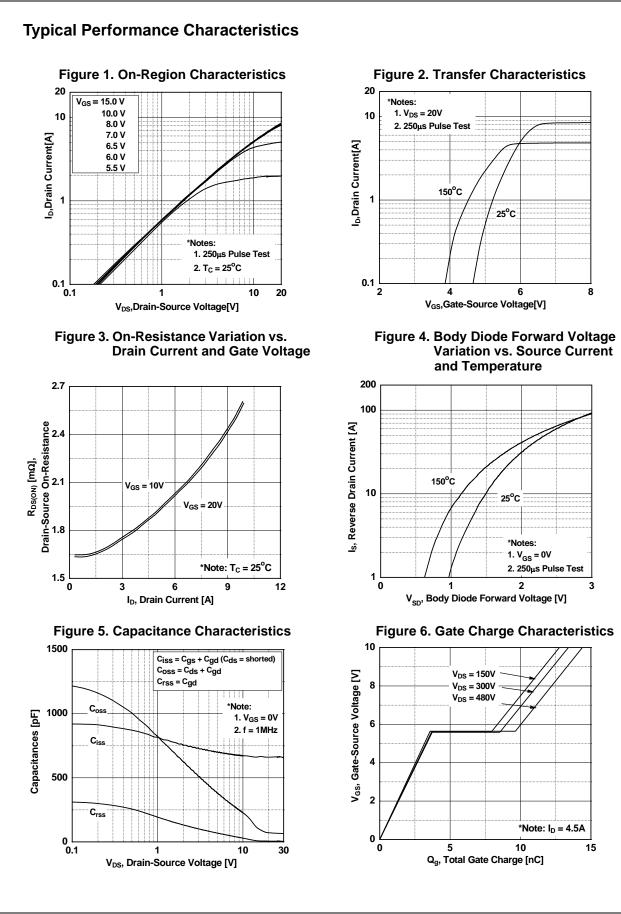
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Device Marking Device		Package	age Reel Size Tap		Таре	e Width		Quantit	y	
FDP6N6	0ZU	FDP6N60ZU	TO-220		-		-		50	
FDPF6N60ZUT FDPF6N60ZUT TO-2		TO-220F	=	-		-		50		
Electrica	l Char	acteristics T _c =	25°C unless o	otherwise r	noted					
Symbol		Parameter			Test Conditions	5	Min.	n. Typ.	Max.	Units
Off Charac	teristic	s								
BV _{DSS}	Drain to	o Source Breakdown Vo	oltage	I _D = 250μ	A, V _{GS} = 0V, T _J	= 25°C	600	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{,l}}$	Breakdown Voltage Temperature Coefficient		Iro	$I_D = 250 \mu A$, Referenced to $25^{\circ}C$		-	0.75	-	V/°C	
5			$V_{DS} = 600$	0V, V _{GS} = 0V		-	-	25		
IDSS	Zero Gate Voltage Drain Current		nt L	-	DV, T _C = 125°C		-	-	250	μA
I _{GSS}	Gate to Body Leakage Current				$VV, V_{DS} = 0V$		-	-	±10	μΑ
On Charac	teristic	S								
V _{GS(th)}	Gate Threshold Voltage			$V_{GS} = V_{DS}, I_{D} = 250 \mu A$			3.0	-	5.0	V
R _{DS(on)}	Static D	Drain to Source On Res	istance	$V_{GS} = 10V, I_D = 2.25A$			-	1.7	2.0	Ω
9 _{FS}	Forward Transconductance			V _{DS} = 40V, I _D = 2.25A			-	3.5	-	S
Dynamic C _{Ciss}		eristics apacitance					-	650	865	pF
C _{oss}	Output	Itput Capacitance		$V_{DS} = 25V, V_{GS} = 0V$		-	75	100	pF	
C _{rss}	Revers	e Transfer Capacitance		f = 1MHz		-	5	10	pF	
Q _g	Total G	otal Gate Charge at 10V					-	14.5	20	nC
Q _{gs}	Gate to	Gate to Source Gate Charge Gate to Drain "Miller" Charge		$V_{DS} = 480V, I_D = 4.5A$ $V_{GS} = 10V$ (Note 4)		-	4	-	nC	
Q _{gd}	Gate to					-	6	-	nC	
Switching	Charac	teristics		<u>.</u>		<u>+</u>	L.			
t _{d(on)}		Turn-On Delay Time						19	48	ns
t _r		n-On Rise Time		V _{DD} = 300V, I _D = 4.5A			-	25	60	ns
t _{d(off)}		ff Delay Time		$R_{G} = 25\Omega, V_{GS} = 10V$		-	-	25	60	ns
t _f		furn-Off Fall Time			(Note 4)		-	45	100	ns
Drain-Sou	ce Dio	de Characteristic	S							
I _S	Maximum Continuous Drain to Source Diode Forward Current						-	-	4.5	Α
I _{SM}	Maximu	aximum Pulsed Drain to Source Diode For			rward Current		-	-	18	Α
V _{SD}	Drain to	Source Diode Forward	l Voltage	$V_{GS} = 0V, I_{SD} = 4.5A$			-	-	1.6	V
t _{rr}	Reverse	e Recovery Time			, I _{SD} = 4.5A		-	36	-	ns
Q _{rr}	Daviana	e Recovery Charge	$dI_{F}/dt = 100A/\mu s$		-	37	-	nC		

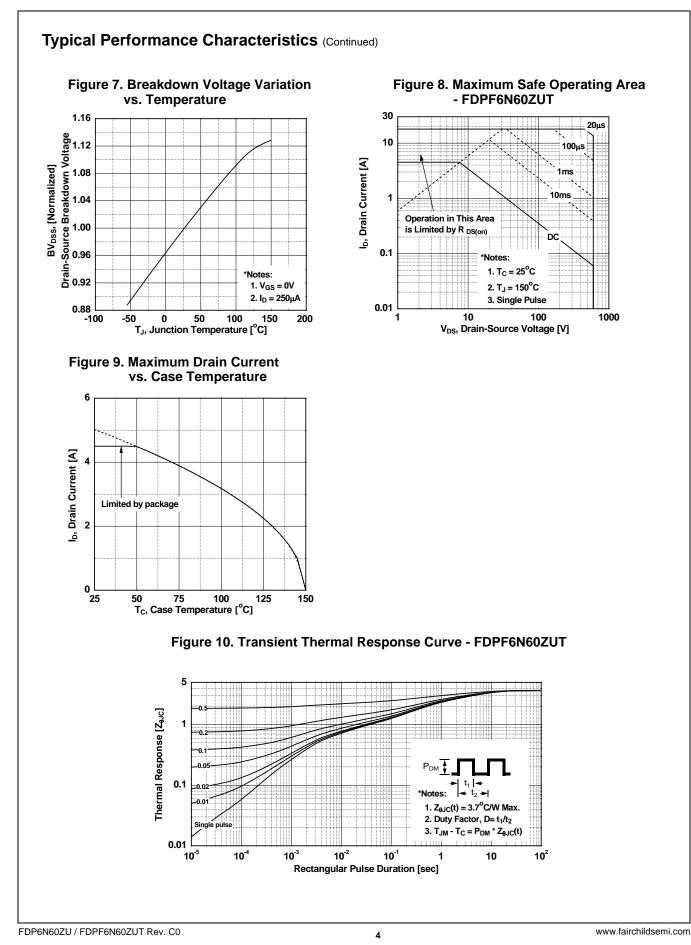
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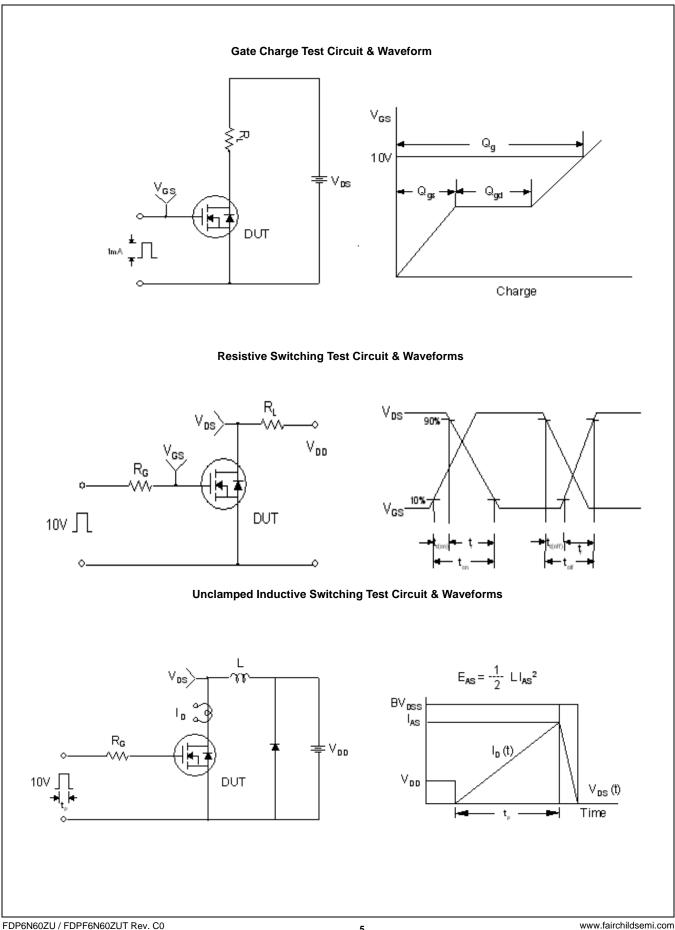
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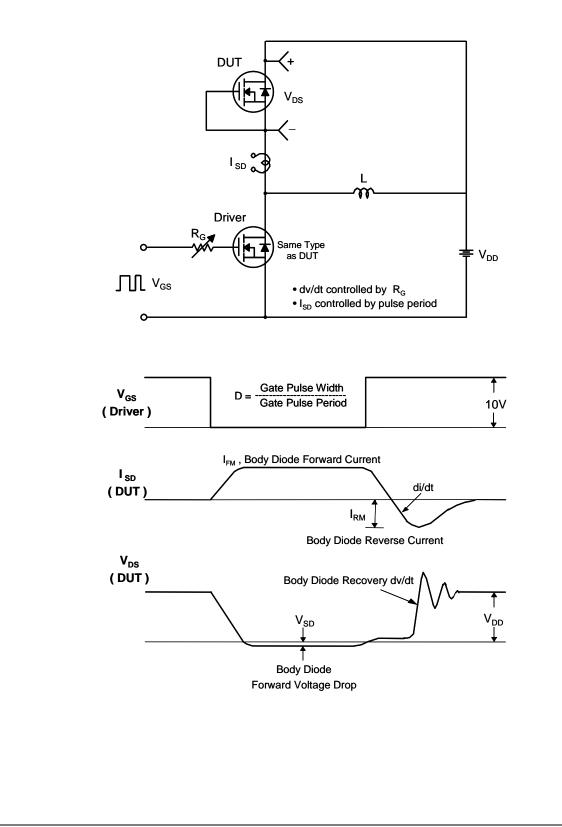


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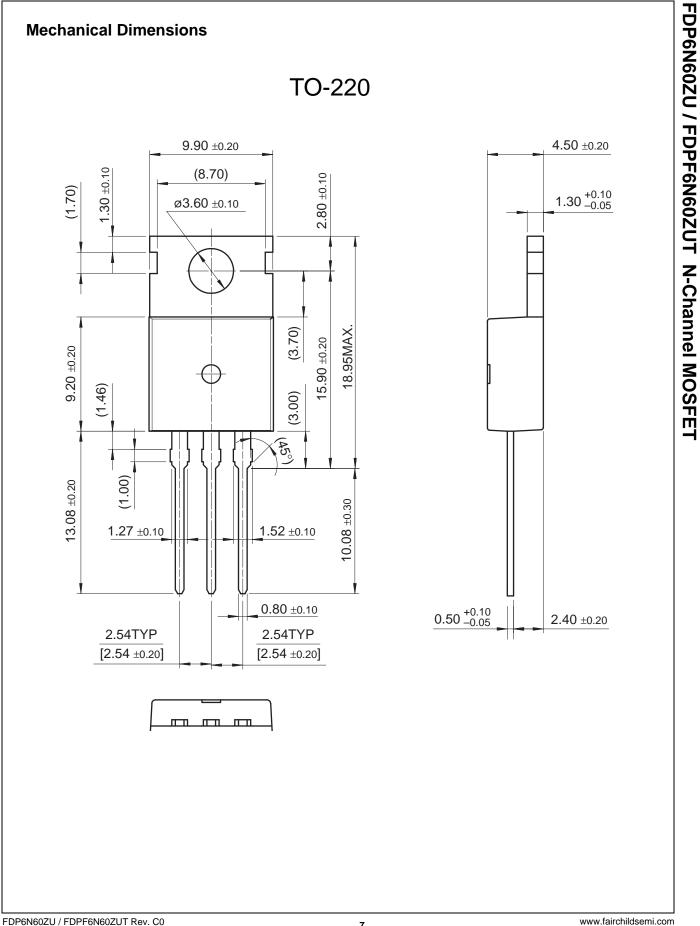


Peak Diode Recovery dv/dt Test Circuit & Waveforms

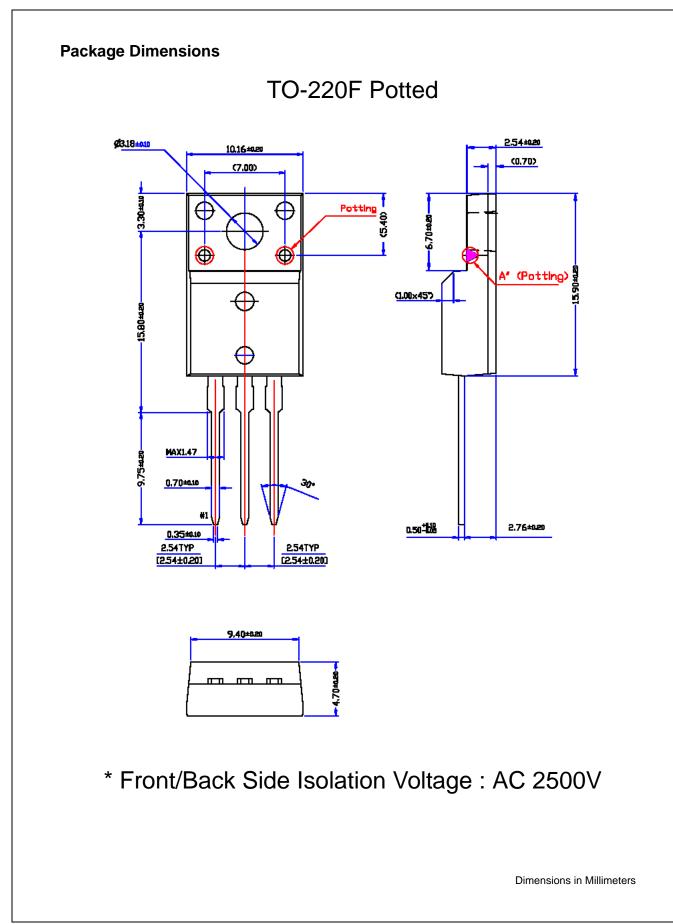


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